

# **UTC** UNISONIC TECHNOLOGIES CO., LTD

# **UTT4N10**

# **3.5A, 100V N-CHANNEL TRENCHMOS LOGIC** LEVEL FET

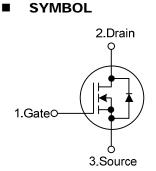
#### DESCRIPTION

The UTC UTT4N10 is an N-Channel Trench MOS Logic Level FET, it uses UTC's advanced technology to provide customers with a minimum on-state resistance and low gate charge.

The UTC UTT4N10 is suitable for consumer, computing and communications, etc.

#### **FEATURES**

\* R<sub>DS(ON)</sub> < 250mΩ @ V<sub>GS</sub>=5V, I<sub>D</sub>=1.75A

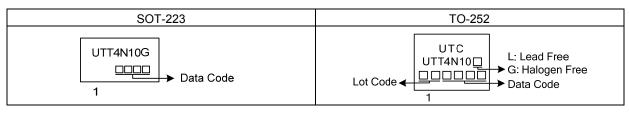


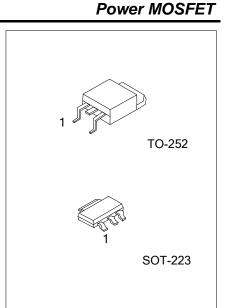
#### ORDERING INFORMATION

Ordering	Deekees	Pin Assignment			Deaking		
Lead Free	Halogen Free	Package	1	2	3	Packing	
-	UTT4N10G-AA3-R	SOT-223	G	D	S	Tape Reel	
UTT4N10L-TN3-R	UTT4N10G-TN3-R	TO-252	G	D	S	Tape Reel	
Note: Pin Assignment: G: Gate D: Drain S: Source							

UTT4N10 <u>Ģ-AA3-Ŗ</u>	
(1)Packing Type	(1) R: Tape Reel
(2)Package Type	(2) AA3: SOT-223, TN3: TO-252
(3)Green Package	(3) G: Halogen Free and Lead Free, L: Lead Free

## MARKING





# ■ **ABSOLUTE MAXIMUM RATINGS** (T<sub>J</sub>=25°C, unless otherwise specified)

PARAMETER			SYMBOL	RATINGS	UNIT
Drain-Source Voltage Tյ≥25°C, Tյ≤150°C			V <sub>DSS</sub>	100	V
Drain-Gate Voltage	T <sub>J</sub> ≥25°C, T <sub>J</sub> ≤	150°C, R <sub>GS</sub> =20kΩ	V <sub>DGR</sub>	100	V
Gate-Source Voltage			V <sub>GSS</sub>	±16	V
Drain Current	Continuous	T <sub>C</sub> =100°C, V <sub>GS</sub> =5V		2.2	А
	Continuous	T <sub>C</sub> =25°C, V <sub>GS</sub> =5V	ID	3.5	А
	Pulsed	T <sub>C</sub> =25°C, t <sub>p</sub> ≤10µs	I <sub>DM</sub>	14	А
Non-Repetitive $V_{GS}$ =5V, $V_{DD}$ ≤15V, $R_{GS}$ =50 $\Omega$ , Avalanche Current Unclamped		I <sub>AS</sub>	3.5	А	
Non-Repetitive Avalanche Energy	V <sub>GS</sub> =5V, V <sub>DD</sub> ≤15V, R <sub>GS</sub> =50Ω, I <sub>D</sub> =3.5A, Unclamped, t <sub>o</sub> =0.2ms		E <sub>AR</sub>	45	mJ
Device Disain ation	SOT-223 TO-252		PD	6.9	W
Power Dissipation					W
Junction Temperature	•		T」 -65~+150		°C
Storage Temperature Range			T <sub>STG</sub>	-65~+150	°C

Note: Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

## ■ THERMAL CHARACTERISTICS

PARAMETER		SYMBOL	RATINGS	UNIT	
Junction to Ambient	SOT-223	0	150	°C/W	
	TO-252	θ <sub>JA</sub>		°C/W	

# ELECTRICAL CHARACTERISTICS

PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT		
OFF CHARACTERISTICS									
Drain-Source Breakdown Voltage		BV <sub>DSS</sub>	I <sub>D</sub> =250μA, V <sub>GS</sub> =0V, T <sub>J</sub> =-55°C	89			V		
			I <sub>D</sub> =250μA, V <sub>GS</sub> =0V, T <sub>J</sub> =25°C	100	130		V		
Gate-Source Leakage Current	Forward	I <sub>GSS</sub>	V <sub>GS</sub> =+10V, V <sub>DS</sub> =0V, T <sub>J</sub> =25°C		10	100	nA		
	Reverse		V <sub>GS</sub> =-10V, V <sub>DS</sub> =0V, T <sub>J</sub> =25°C		-10	-100	nA		
ON CHARACTERISTICS									
Gate Threshold Voltage		V <sub>GS(TH)</sub>	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250µA, T <sub>J</sub> =25°C			3	V		
Static Drain-Source On-State Resistance		R <sub>DS(ON)</sub>	V <sub>GS</sub> =5V, I <sub>D</sub> =1.75A, T <sub>J</sub> =25°C		200	250	mΩ		
			V <sub>GS</sub> =5V, I <sub>D</sub> =1.75A, T <sub>J</sub> =150°C			575	mΩ		
SWITCHING PARAMETERS							-		
Turn-ON Delay Time		t <sub>D(ON)</sub>			30		ns		
Rise Time		t <sub>R</sub>	V <sub>DS</sub> =50V, V <sub>GS</sub> =10V, R <sub>L</sub> =0.5Ω,		30		ns		
Turn-OFF Delay Time		t <sub>D(OFF)</sub>	$R_{G(ext)}=6\Omega, T_{J}=25^{\circ}C$		140		ns		
Fall-Time		t⊨			30		ns		
Total Gate Charge		$Q_{G}$	/ <sub>GS</sub> =10V, V <sub>DS</sub> =50V, I <sub>D</sub> =1.3A,		20		nC		
Gate to Source Charge		Q <sub>GS</sub>	$V_{GS} = 10^{\circ}, V_{DS} = 30^{\circ}, I_D = 1.3^{\circ}, I_C = 1.3^{\circ}, $		3.7		nC		
Gate to Drain Charge		$Q_{GD}$	1 - 23 C		3.6		nC		
SOURCE- DRAIN DIODE RATI	NGS AND	CHARACTER	RISTICS						
Maximum Body-Diode Continuous		١ <sub>S</sub>	T,⊨25°C			3.5	А		
Current			1j-25 C			3.5	A		
Maximum Body-Diode Pulsed Current		I <sub>SM</sub>	T <sub>J</sub> =25°C, t <sub>p</sub> ≤10µs			14	Α		
Drain-Source Diode Forward Voltage		V <sub>SD</sub>	I <sub>S</sub> =3.5A, V <sub>GS</sub> =0V, T <sub>J</sub> =25°C		0.87	1.5	V		
Body Diode Reverse Recovery	Time	t <sub>RR</sub>	I <sub>S</sub> =3.5A, V <sub>GS</sub> =0V, dI <sub>S</sub> /dt=-100A/µs,		50		ns		
Body Diode Reverse Recovery	Charge	Q <sub>RR</sub>	V <sub>DS</sub> =30V, T <sub>J</sub> =25°C		100		nC		



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